TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (L^2 - π -MOSV)

2SK2231

Chopper Regulator, DC/DC Converter and Motor Drive Applications

4 V gate drive

• Low drain-source ON-resistance : $R_{DS(ON)} = 0.12 \Omega \text{ (typ.)}$

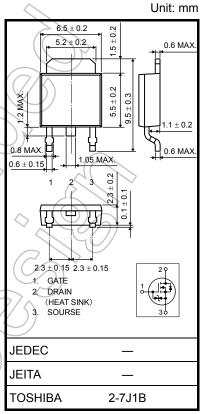
• High forward transfer admittance : $|Y_{fs}| = 5.0 \text{ S (typ.)}$

Low leakage current : I_{DSS} = 100 μA (max) (V_{DS} = 60 V)

• Enhancement mode : V_{th} = 0.8 to 2.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Character	istic	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	60	V
Drain-gate voltage (R_{GS} = 20 k Ω)		V_{DGR}	60	A
Gate-source voltage		V_{GSS}	±20	> v
Drain current	DC (Note 1)	I _D	5	Α
	Pulse (Note 1)	I _{DP}	20	A
Drain power dissipatio	n (Tc = 25°C)	P _D	20	W
Single-pulse avalanch	e energy (Note 2)	EAS	129	mJ
Avalanche current		lar,	5	Α `
Repetitive avalanche	energy (Note 3)	(E _{AR}	2	mJ
Channel temperature		Tch	150	~c
Storage temperature r	ange	// T _{stg}	-55 to 150	₹/\°C



Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th} (ch-c)	6.25	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	125	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 25 V, T_{ch} = 25°C (initial), L = 7 mH, R_G = 25 Ω , I_{AR} = 5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.

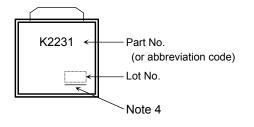
Electrical Characteristics (Ta = 25°C)

Chara	cteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cutoff curr	rent	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	60	_	_	V
Gate threshold	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	0.8	_	2.0	V
Drain-source ON-resistance		R _{DS (ON)}	V _{GS} = 4 V, I _D = 1.3 A		0.20	0.30	Ω
			V _{GS} = 10 V, I _D = 2.5 A) \)	0.12	0.16] 12
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	3.0	5.0	_	S
Input capacitano	ce	C _{iss})	370	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	60	_	pF
Output capacita	nce	Coss		_	180	_	
Switching time	Rise time	t _r	V _{GS} _{0V} I _D =2.5A V _{OUT}	- (18	<u> </u>	
	Turn-on time	t _{on}	$R_L = 12\Omega$		25) –	
	Fall time	t _f	V _{DD} ≒30V	()	55	_	ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\rm W} = 10 \mu \rm s$) –	170	_	
Total gate charge (gate-source plus gate-drain)		Qg		_	12	_	
Gate-source charge		Q _{gs}	$V_{DD} \approx 48 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$	_	8	_	nC
Gate-drain ("Mil	ler") charge	Q _{gd}		_	4	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

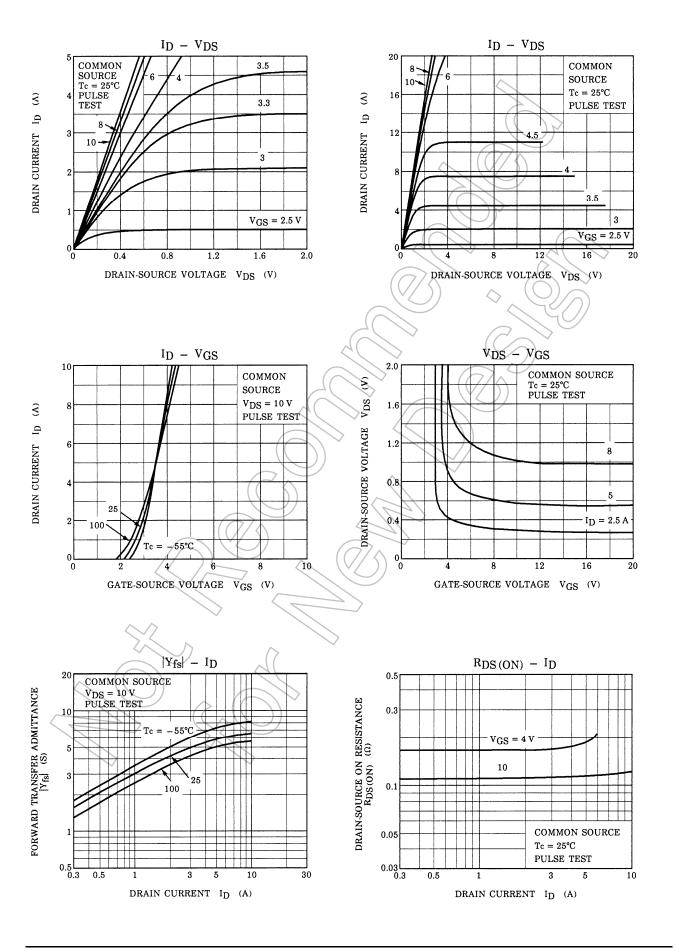
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	IDR		_	_	5	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	20	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 5 A, V _{GS} = 0 V, dI _{DR} / dt = 50 A/μs	1	70	_	ns
Reverse recovery charge	Q _{rr}		_	0.1	_	μC

Marking

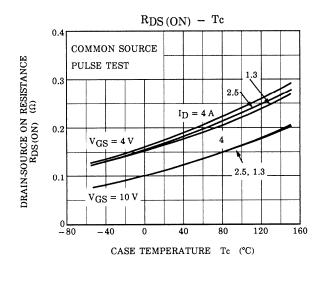


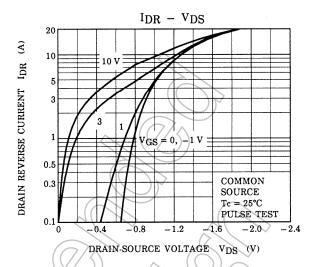
Note 4 : A line under a Lot No. identifies the indication of product Labels [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

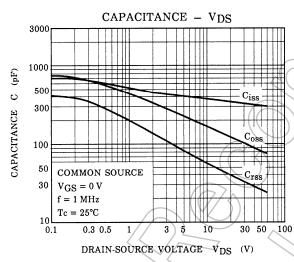
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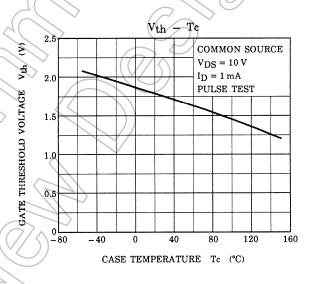


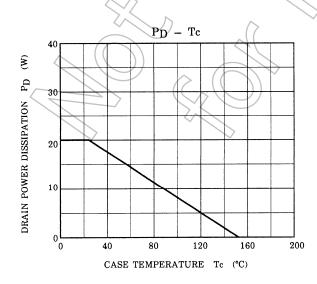
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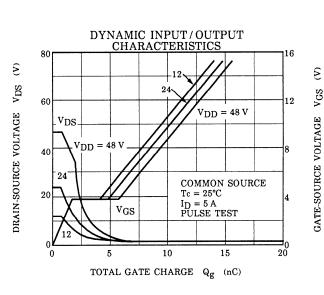




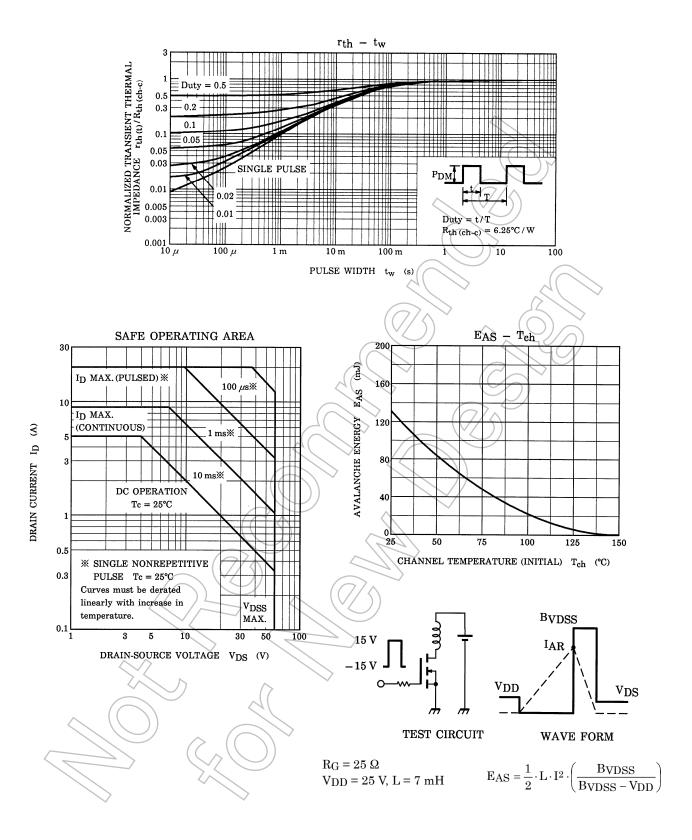








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